

## Acknowledgment

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Product Assurance Committee	IPC/WHMA-A-620 Joint Working Group	
<b>Chair</b> Mel Parrish Soldering Technology International	Garry McGuire, SRSIS NASA/Goddard Space Flight Center	Vernon Judy, Sr. Qualastat Electronics
<b>Technical Liaisons of the IPC Board of Directors</b> Dr. William Beckenbaugh Sanmina	James Moffitt Moffitt Consulting Services Ralph Hersey Ralph Hersey Associates	Ray Sweeney Unlimited Services John A Mastroianni Intercon, Inc.

### Members of the IPC/WHMA-A-620 Joint Working Group

Troy Agner, ESI America Inc.	Leo P. Lambert, EPTAC Corporation
Tim Armstrong, Global Wire Technologies	Charles A. Lawson,
Roman Belej, Data Cable Company, Inc.	Frederic W. Lee, Northrop Grumman Norden Systems
G. Les Bogert, Bechtel Plant Machinery, Inc.	John A. Mastroianni, Intercon, Inc.
Kim Boyce, Reflect Scientific	Mike Mathews, Electrotest
Maik Brockey, Global Wire Technologies	Karla Maxwell, RF Industries
Byron Case, L-3 Communications	William Dean May, NSWC - Crane
Alan S. Cash, Northrop Grumman Corporation	Wade McFaddin, Nextek, Inc.
Gary W. Chance, Grubi Communications Inc.	Garry D. McGuire, SRSIS, NASA/Goddard Space Flight Center
Dr. James C. Chiang, Nextek, Inc.	Randy McNutt, Northrop Grumman
Judy Childers, Electronic Theatre Controls	Brett A. Miller, USA Harness, Inc.
Maik Cross, Lockheed Martin	James H. Moffitt, Moffitt Consulting Services
Ramon A. Diaz, Solectron Technology Inc.	Anthony M. Monteiro, United Technologies
Bruce Dudley, SAI Spectrum Assembly, Inc.	Ken A. Moore, Omni Training Corp.
Eddie Fields, J.C.R. Industries Inc.	Stu Moorhead, Unison Industries
Lila Floria, Electronic Manufacturing, Inc.	Gordon Morris, Raytheon System Technology
Richard Francis, Carlyle Inc.	Kirk Mueller, Boeing Phantom Works
Mahendra S. Gandhi, Space Systems/Loral	Kirk D. Mueller, Raytheon Systems Company
Constantino J. Gonzalez, ACME, Inc.	Mary Muller, Eldec Corporation
Michael R. Green, Lockheed Martin Space Systems	Terry L. Munson, CSL Inc.
Hue T. Green, Lockheed Martin Space Systems	Charles C. Myers, Storage Technology Corp.
Ralph J. Hersey, Ralph Hersey Associates	Conrad Neri, RF Industries
Charles Highlan, SCI Systems Inc.	Riley L. Northam, EMPF/ACI
David Hollesen, Lucent Technologies, Inc.	John S. Norton, Xerox Corporation
Ronald Hotchkiss, Innovative Technology	Seppo Nuppola, Nokia Networks Oyj
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James Jenkins, Harris Corporation	Gregg Owens, Omni Training Corp.
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Ray Sweeney, Unlimited Services

Blen F. Talbot, L-3 Communications

Ronald E. Thompson, NSWC - Crane

Linda Tucker, Blackfox Training Institute

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<sup>1</sup> Figures 3-9, 4-1, 4-3, 4-4, 4-13, 4-14, 4-15, 4-30, 4-33, 4-36, 4-37, 4-39, 4-40, 4-44, 4-45, 4-46, 4-47, 4-51, 4-52, 4-53, 4-54, 4-55, 4-56, 4-57, 4-58, 4-59 are ©Omni Training Corporation, used by permission.